

Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

| Characteris | Symbol | Value | Unit | | |
|-----------------------------------|--|-------|------------------|----------------|---|
| Drain-Source Voltage | | | V _{DSS} | -20 | V |
| Gate-Source Voltage | | | V _{GSS} | ±6 | V |
| Continuous Drain Current (Note 5) | $\begin{array}{c} \text{Steady} & T_{\text{A}} = +25^{\circ}\text{C} \\ \text{State} & T_{\text{A}} = +85^{\circ}\text{C} \end{array}$ | | ID | -0.82 -0.54 | А |
| Pulsed Drain Current (Note 6) | | | I _{DM} | -3 | А |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit | |
|--|--------|-----------------------------------|-------------|------|
| Power Dissipation (Note 5) | | PD | 0.31 | W |
| Thermal Resistance, Junction to Ambient $@T_A = +25^{\circ}C$ (Note 5) | | $R_{\theta JA}$ | 398 | °C/W |
| Operating and Storage Temperature Range | | T _J , T _{STG} | -55 to +150 | °C |

Notes: 5. Device mounted on FR-4 PCB, with minimum recommended pad layout. 6. Repetitive rating, pulse width limited by junction temperature.

Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

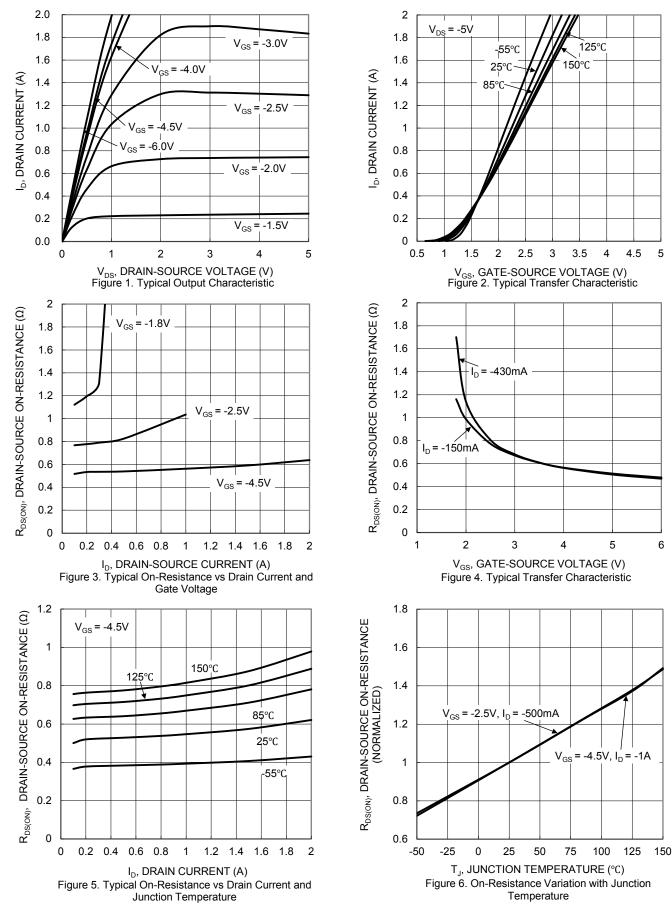
| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|---|---------------------|------|-------|------|------|---|--|
| OFF CHARACTERISTICS (Note 7) | | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | -20 | - | - | V | V_{GS} = 0V, I _D = -250µA | |
| Zero Gate Voltage Drain Current T_J = +25°C | I _{DSS} | - | - | -100 | nA | V_{DS} = -20V, V_{GS} = 0V | |
| Gate-Source Leakage | I _{GSS} | - | - | ±2.0 | μA | V_{GS} = ±4.5V, V_{DS} = 0V | |
| ON CHARACTERISTICS (Note 7) | | | | | | | |
| Gate Threshold Voltage | V _{GS(TH)} | -0.5 | - | -1.0 | V | $V_{DS} = V_{GS}$, $I_D = -250 \mu A$ | |
| | | - | 0.5 | 0.75 | 5 Ω | V_{GS} = -4.5V, I _D = -430mA | |
| Static Drain-Source On-Resistance | R _{DS(ON)} | | 0.7 | 1.05 | | V_{GS} = -2.5V, I _D = -300mA | |
| | | | 1.0 | 1.5 | | V_{GS} = -1.8V, I _D = -150mA | |
| Forward Transfer Admittance | Y _{fs} | - | 0.9 | - | S | V _{DS} = -10V, I _D = -250mA | |
| Diode Forward Voltage | V _{SD} | | -0.8 | -1.2 | V | V _{GS} = 0V, I _S = -150mA | |
| DYNAMIC CHARACTERISTICS (Note 8) | | | | | | | |
| Input Capacitance | C _{iss} | - | 59.76 | - | pF | | |
| Output Capacitance | Coss | - | 12.07 | - | pF | └V _{DS} = -16V, V _{GS} = 0V, - f = 1.0MHz | |
| Reverse Transfer Capacitance | C _{rss} | - | 6.36 | - | pF | 1 1.00012 | |
| Total Gate Charge | Qg | - | 622.4 | - | рС | | |
| Gate-Source Charge | Q _{gs} | - | 100.3 | - | рС | −V _{GS} = -4.5V, V _{DS} = -10V, −I _D = -250mA | |
| Gate-Drain Charge | Q _{gd} | - | 132.2 | - | рС | | |
| Turn-On Delay Time | t _{D(ON)} | - | 5.1 | - | ns | | |
| Turn-On Rise Time | t _R | - | 8.1 | - | ns | $V_{DD} = -10V, V_{GS} = -4.5V,$ | |
| Turn-Off Delay Time | t _{D(OFF)} | - | 28.4 | - | ns | R _L = 47Ω, R _G = 10Ω, - I _D = -200mA | |
| Turn-Off Fall Time | t _F | - | 20.7 | - | ns | | |

Notes: 7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to production testing.

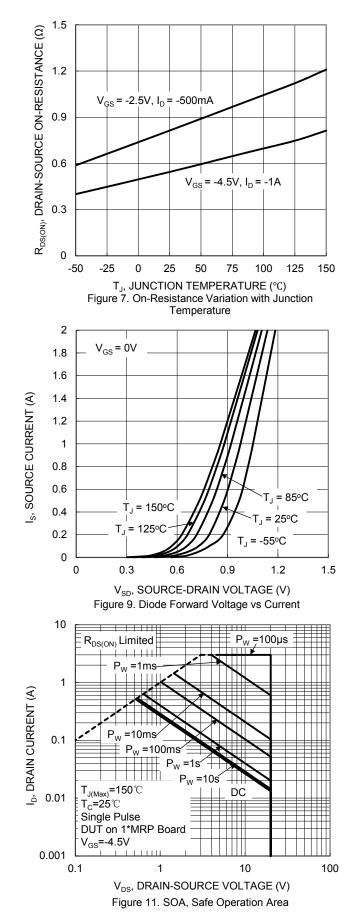


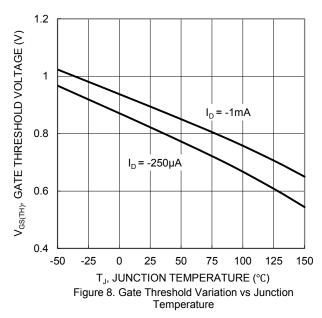
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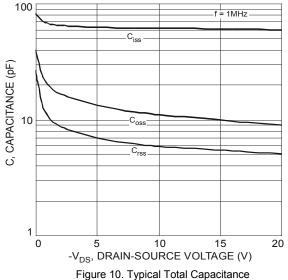


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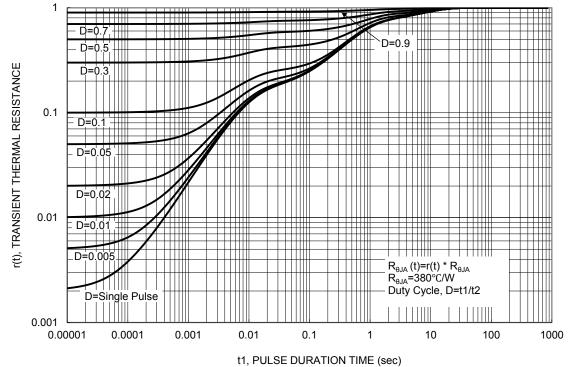
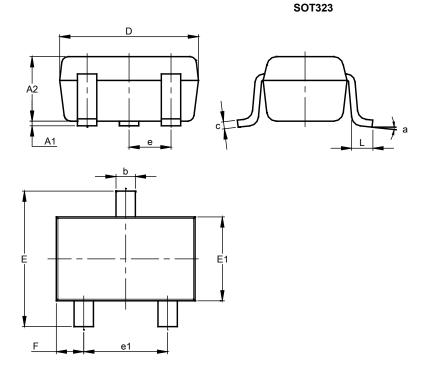


Figure 12. Transient Thermal Resistance



Package Outline Dimensions

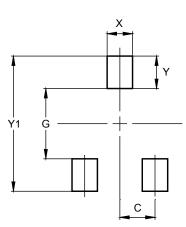
Please see http://www.diodes.com/package-outlines.html for the latest version.



| SOT323 | | | | | |
|----------------------|-----------|-------|-------|--|--|
| Dim | Min | Max | Тур | | |
| A1 | 0.00 | 0.10 | 0.05 | | |
| A2 | 0.90 | 1.00 | 0.95 | | |
| b | 0.25 | 0.40 | 0.30 | | |
| С | 0.10 | 0.18 | 0.11 | | |
| D | 1.80 | 2.20 | 2.15 | | |
| E | 2.00 | 2.20 | 2.10 | | |
| E1 | 1.15 | 1.35 | 1.30 | | |
| е | 0.650 BSC | | | | |
| e1 | 1.20 | 1.40 | 1.30 | | |
| F | 0.375 | 0.475 | 0.425 | | |
| L | 0.25 | 0.40 | 0.30 | | |
| а | 8° | | | | |
| All Dimensions in mm | | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



| Dimensions | Value (in mm) | | | |
|------------|------------------|--|--|--|
| С | 0.650 | | | |
| G | 1.300 | | | |
| Х | 0.470 | | | |
| Y | 0.600 | | | |
| Y1 | 2.500 | | | |

SOT323



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